

Datasheet revision 1.3 www.chipquik.com

# Solder Wire Sn63/Pb37 Rosin Activated with 2.2% Flux Core 8oz Spool

## **Product Highlights**

## RA (Rosin Activated)

2.2% Flux Core

A stronger activated flux for hard to solder surfaces.

CHIPQUIK® RASW solder wire post process residue may be left on for most non-critical applications, but should be removed from any critical applications using solvent cleaning, such as CHIPQUIK® COSOLV165 or COSOLV175, followed by COSOLV55 or IPA rinse.

#### **Specifications**

Alloy: Sn63/Pb37
Wire Diameter: 0.031" (0.8mm)
Flux Type: Rosin Activated

Flux Classification: ROM1

Melting Point: 183°C (361°F)
Packaging: 8oz spool
Shelf Life: >60 months

#### **Test Results**

Test Requirement	Result
IPC-TM-650: 2.3.32	L: No breakthrough
IPC-TM-650: 2.6.15	M: Slight corrosion
IPC-TM-650: 2.3.28.1	M: 0.5-2.0%
IPC-TM-650: 2.6.14.1	L: <1 decade drop (No-clean)
IPC-TM-650: 2.6.3.7	L: ≥100MΩ (No-clean)
IPC-TM-650: 3.4.2.5	Clear and free from precipitation
Electronic Industry Citizenship Coalition (EICC)	Compliant
Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains Lead (Pb) CAS# 7439-92-1 No other SVHC present
	IPC-TM-650: 2.3.32 IPC-TM-650: 2.6.15 IPC-TM-650: 2.3.28.1 IPC-TM-650: 2.6.14.1 IPC-TM-650: 2.6.3.7  IPC-TM-650: 3.4.2.5 Electronic Industry Citizenship Coalition (EICC) Articles 33 and 67 of Regulation (EC)

## **Conforms to the following Industry Standards:**

J-STD-004B, Amendment 1 (Solder Fluxes):

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders):

RoHS 3 Directive (EU) 2015/863:

Yes

No